



**Photocoupler**  
**Product Data Sheet**  
LTV-358T

Spec No. :DS70-2001-022  
Effective Date: 05/04/2022  
Revision: M

**LITE-ON DCC**

**RELEASE**

**BNS-OD-FC001/A4**

## Photocoupler LTV-358T series

### 1. DESCRIPTION

#### 1.1 Features

- Current transfer ratio ( CTR : MIN. 80% at  $I_F = 5\text{mA}$ ,  $V_{CE} = 5\text{V}$  )
- Current transfer ratio ( CTR : MIN. 20% at  $I_F = 1\text{mA}$ ,  $V_{CE} = 5\text{V}$  )
- High input-output isolation voltage (  $V_{iso} = 3,750\text{Vrms}$  )
- High collector-emitter voltage (  $V_{CEO} = 120\text{V}$  )
- Mini-flat package : LTV-358T series
- SOP-4 package
- ESD pass HBM 8000V / MM2000V / CDM2000V
- Safety approval
  - UL 1577 & cUL
  - VDE DIN EN60747-5-5 (VDE 0884-5) ,
  - CSA CA5A
  - FIMKO/DEMKO/SEMKO/NEMKO
- RoHS Compliance
  - All materials be used in device are followed EU RoHS directive (No.2002/95/EC, 2011/65/EU, and 2015/863).
- MSL class1

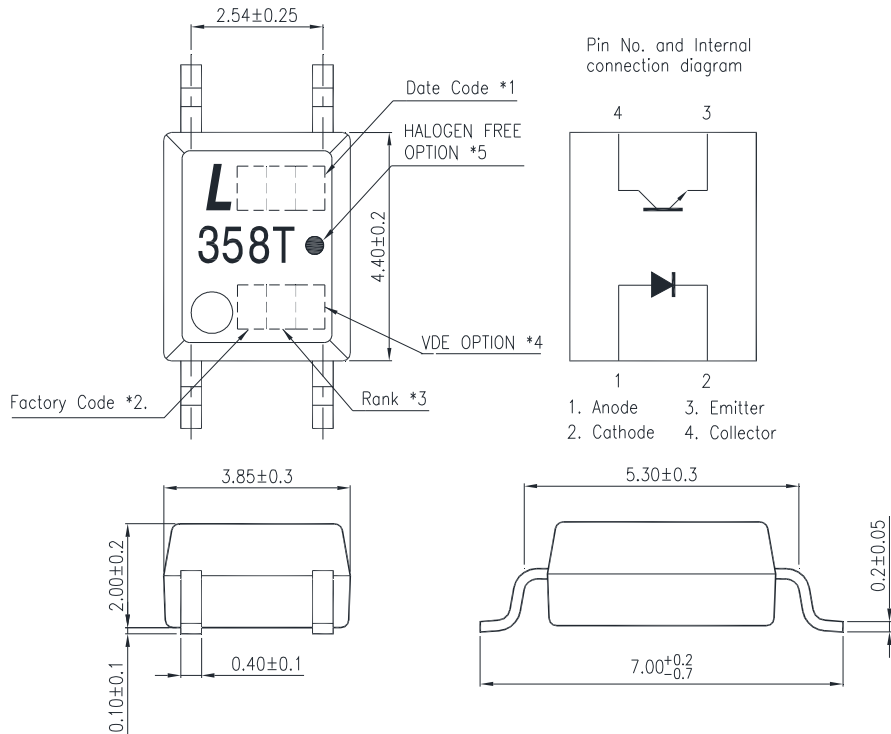
#### 1.2 Applications

- Hybrid substrates that require high density mounting.
- Programmable controllers
- System appliance, measuring instruments

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### 2. PACKAGE DIMENSIONS

#### 2.1 LTV-358T series



#### Notes :

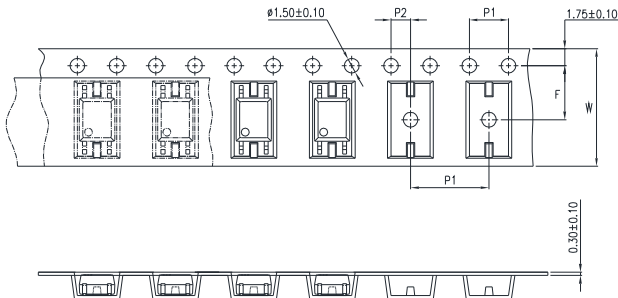
- 1-digit year code, Example : 2010 = A  
2-digit work week ranging from '01' to '53'
- Factory identification mark shall be marked (W: China -CZ, X: China -TJ, Y: Thailand)
- Rank shall be or shall not be marked.
- "4" or "V" for VDE option.
- "●" indicates halogen free option.

\*All dimensions in millimeters.

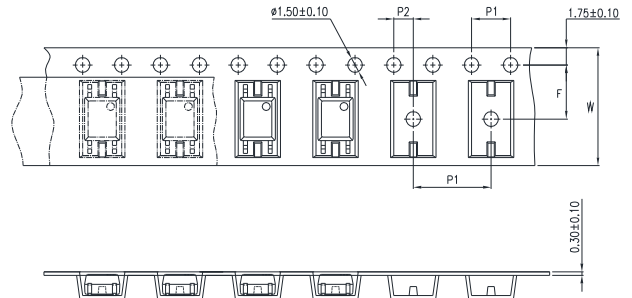
## Photocoupler LTV-358T series

### 3. TAPING DIMENSIONS

#### 3.1 LTV-358T-TP



#### 3.2 LTV-358T



Description	Symbol	Dimension in mm (inch)
Tape wide	W	12±0.3 (0.472)
Pitch of sprocket holes	P <sub>0</sub>	4±0.1 (0.157)
Distance of compartment	F	5.5±0.1 (0.217)
	P <sub>2</sub>	2±0.1 (0.079)
Distance of compartment to compartment	P <sub>1</sub>	8±0.1 (0.315)

#### 3.3 Quantities Per Reel

Package Type	LTV-358T series
Quantities (pcs)	3000

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### 4. RATING AND CHARACTERISTICS

#### 4.1 Absolute Maximum Ratings at Ta=25°C

	Parameter	Symbol	Rating	Unit
Input	Forward Current	$I_F$	50	mA
	Reverse Voltage	$V_R$	6	V
	Power Dissipation	$P$	70	mW
	Junction Temperature	$T_J$	125	°C
Output	Collector - Emitter Voltage	$V_{CEO}$	120	V
	Emitter - Collector Voltage	$V_{ECO}$	6	V
	Collector Current	$I_C$	50	mA
	Collector Power Dissipation	$P_C$	150	mW
	Junction Temperature	$T_J$	125	°C
	Total Power Dissipation	$P_{tot}$	170	mW
1.	Isolation Voltage	$V_{iso}$	3750	$V_{rms}$
	Operating Temperature	$T_{opr}$	-55 ~ +110	°C
	Storage Temperature	$T_{stg}$	-55 ~ +150	°C
2.	Soldering Temperature	$T_{sol}$	260	°C

1. AC For 1 Minute, R.H. = 40 ~ 60%

Isolation voltage shall be measured using the following method.

- (1) Short between anode and cathode on the primary side and between collector and emitter on the secondary side.
- (2) The isolation voltage tester with zero-cross circuit shall be used.
- (3) The waveform of applied voltage shall be a sine wave.

2. For 10 Seconds

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### 4.2 ELECTRICAL OPTICAL CHARACTERISTICS at Ta=25°C

Parameter		Symbol	Min.	Typ.	Max.	Unit	Test Condition
Input	Forward Voltage	$V_F$	—	1.2	1.4	V	$I_F=20\text{mA}$
	Reverse Current	$I_R$	—	—	10	$\mu\text{A}$	$V_R=4\text{V}$
	Terminal Capacitance	$C_t$	—	30	250	pF	$V=0, f=1\text{KHz}$
Output	Collector Dark Current	$I_{CEO}$	—	—	100	nA	$V_{CE}=40\text{V}, I_F=0$
	Collector-Emitter Breakdown Voltage	$BV_{CEO}$	120	—	—	V	$I_C=0.1\text{mA}, I_F=0$
	Emitter-Collector Breakdown Voltage	$BV_{ECO}$	6	—	—	V	$I_E=10\mu\text{A}, I_F=0$
TRANSFER CHARACTERISTICS	Collector Current	$I_C$	4	—	20	mA	$I_F=5\text{mA}$
	1. Current Transfer Ratio	CTR	80	—	400	%	$V_{CE}=5\text{V}$
	Collector Current	$I_C$	0.2	—	—	mA	$I_F=1\text{mA}$
	Current Transfer Ratio	CTR	20	—	—	%	$V_{CE}=5\text{V}$
	Collector-Emitter Saturation Voltage	$V_{CE(sat)}$	—	—	0.2	V	$I_F=20\text{mA}$ $I_C=1\text{mA}$
	Isolation Resistance	$R_{iso}$	$5 \times 10^{10}$	$1 \times 10^{11}$	—	$\Omega$	DC500V, 40 ~ 60% R.H.
	Floating Capacitance	$C_f$	—	0.6	1	pF	$V=0, f=1\text{MHz}$
	Response Time (Rise)	$t_r$	—	4	18	$\mu\text{s}$	$V_{CE}=2\text{V},$ $I_C=2\text{mA}$
	Response Time (Fall)	$t_f$	—	3	18	$\mu\text{s}$	$R_L=100\Omega,$

$$1. \text{ CTR} = \frac{I_C}{I_F} \times 100\%$$

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**5. RANK TABLE OF CURRENT TRANSFER RATIO (CTR)**

Parameter	CTR Rank	Min	Max	Condition
DC Current Transfer Ratio	A	80	160	$I_F=5\text{mA}$ , $V_{CE}=5\text{V}$ , $T_a=25^\circ\text{C}$
	B	130	260	
	C	200	400	
	A or B or C or No Mark	80	400	
	A	>20		$I_F=1\text{mA}$ , $V_{CE}=5\text{V}$ , $T_a=25^\circ\text{C}$
	B	>45		
	C	>70		
	A or B or C or No Mark	>20		

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## 6. CHARACTERISTICS CURVES (TYPICAL PERFORMANCE)

Fig.1 Forward Current vs. Ambient Temperature

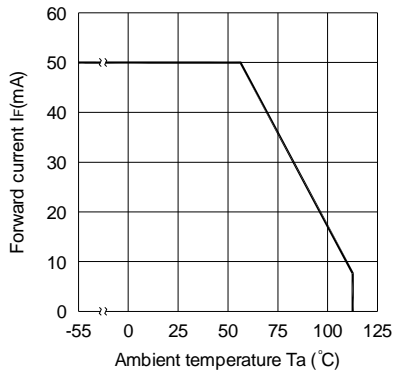


Fig.2 Collector Power Dissipation vs. Ambient Temperature

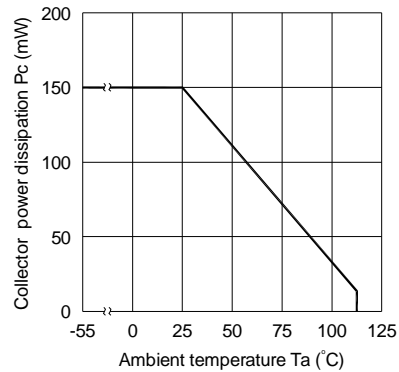


Fig.3 Collector-emitter Saturation Voltage vs. Forward Current

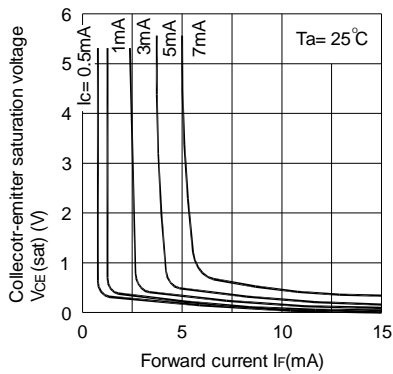


Fig.4 Forward Current vs. Forward Voltage

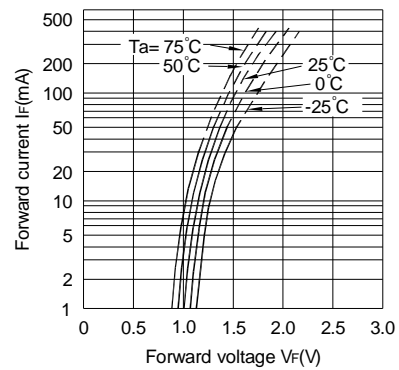


Fig.5 Current Transfer Ratio vs. Forward Current

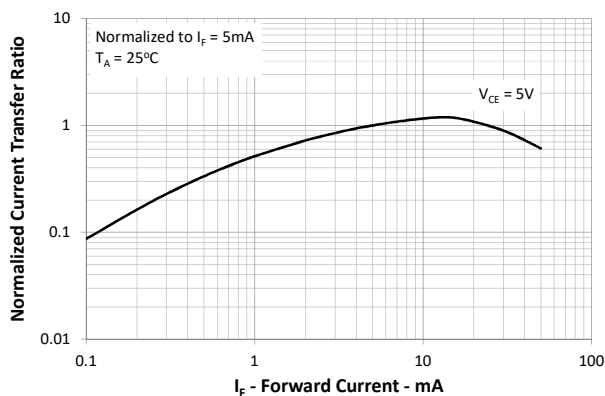
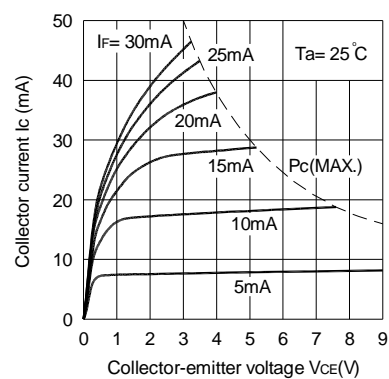


Fig.6 Collector Current vs. Collector-emitter Voltage





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Fig.7 Relative Current Transfer Ratio vs. Ambient Temperature

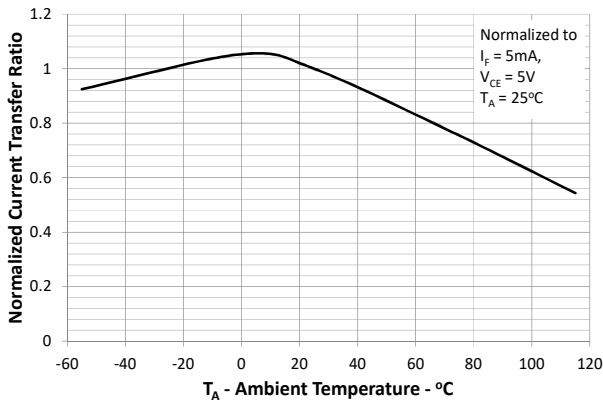


Fig.8 Collector-emitter Saturation Voltage vs. Ambient Temperature

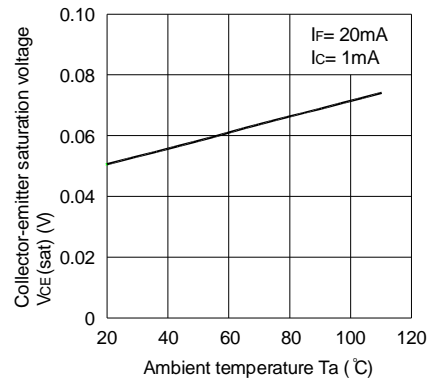


Fig.9 Collector Dark Current vs. Ambient Temperature

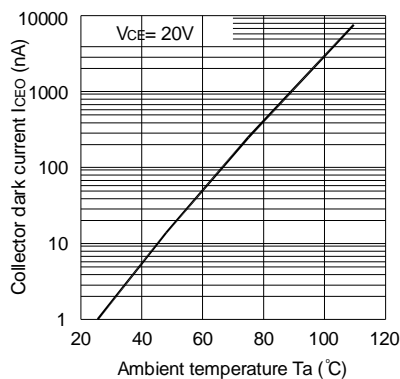


Fig.10 Response Time vs. Load Resistance

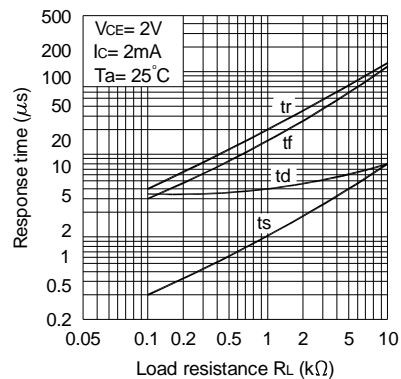
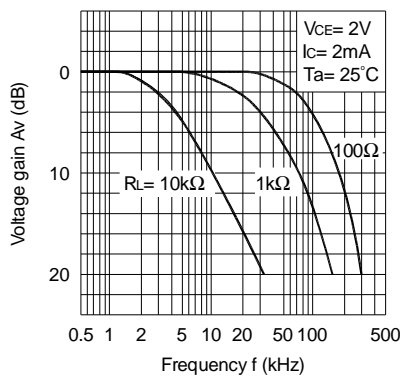
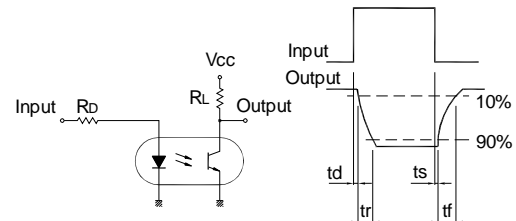


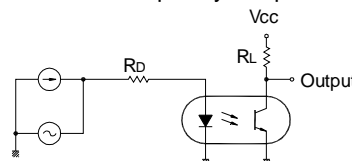
Fig.11 Frequency Response



Test Circuit for Response Time



Test Circuit for Frequency Response



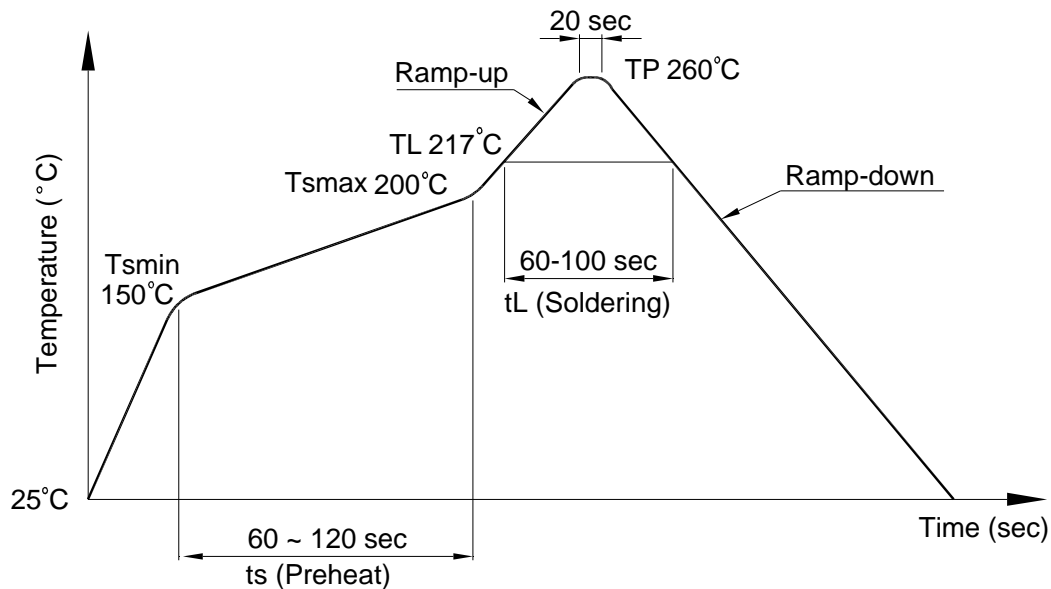
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## 7. TEMPERATURE PROFILE OF SOLDERING

### 7.1 IR Reflow soldering (JEDEC-STD-020C compliant)

One time soldering reflow is recommended within the condition of temperature and time profile shown below. Do not solder more than three times.

Profile item	Conditions
Preheat	
- Temperature Min ( $T_{Smin}$ )	150°C
- Temperature Max ( $T_{Smax}$ )	200°C
- Time (min to max) (ts)	90±30 sec
Soldering zone	
- Temperature ( $T_L$ )	217°C
- Time ( $t_L$ )	60~100 sec
Peak Temperature ( $T_P$ )	260°C
Ramp-up rate	3°C / sec max.
Ramp-down rate	3~6°C / sec



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**7.2 Wave soldering (JEDEC22A111 compliant)**

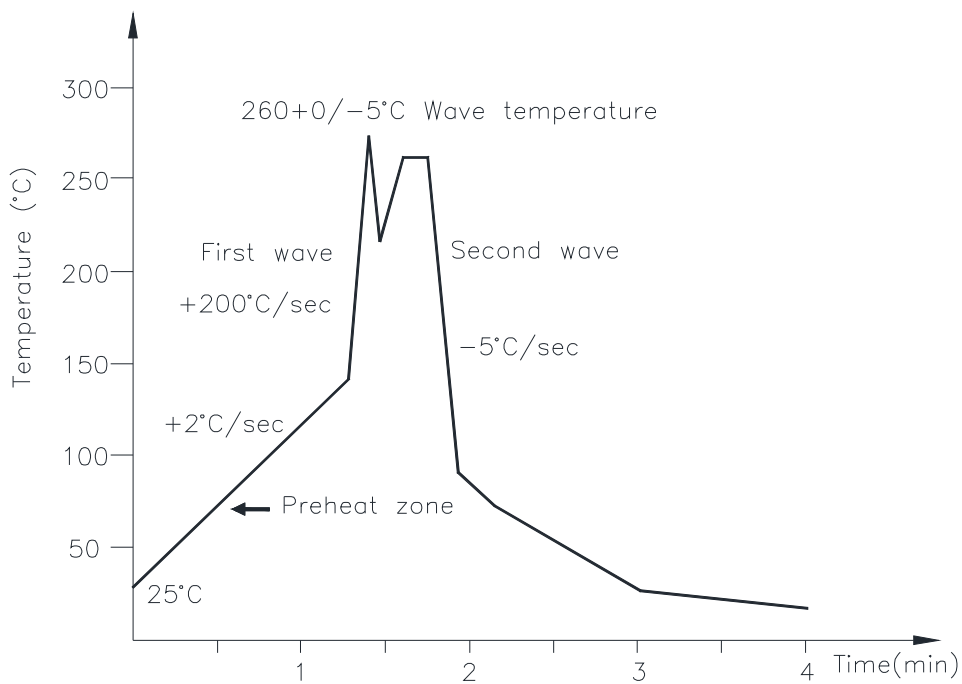
One time soldering is recommended within the condition of temperature.

Temperature:  $260+0/-5^{\circ}\text{C}$

Time: 10 sec.

Preheat temperature: 25 to  $140^{\circ}\text{C}$

Preheat time: 30 to 80 sec.



**7.3 Hand soldering by soldering iron**

Allow single lead soldering in every single process. One time soldering is recommended.

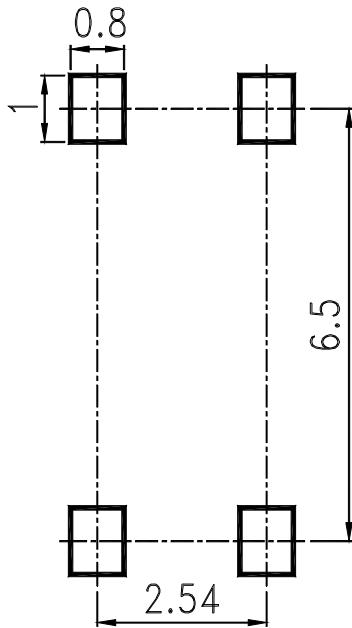
Temperature:  $380+0/-5^{\circ}\text{C}$

Time: 3 sec max.

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**8. RECOMMENDED FOOT PRINT PATTERNS (MOUNT PAD)**

Unit: mm



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**9. NAMING RULE**

**LTV-358T-(1)-(2)-G-(4)**

DEVICE PART NUMBER

- (1) TAPING TYPE (TP, no suffix)  
LTV-358T has tape and reel solution.  
Please refer to orientation of taping on Page 3
- (2) CTR RANK  
Please refer to Page 6
- (3) Halogen free option
- (4) Customer code

Example : LTV-358T-TP-A-G

**LTV 358T (1) (2)-V-G-(5)**

DEVICE PART NUMBER

- (1) TAPING TYPE (TP, no suffix)  
LTV-358T has tape and reel solution.  
Please refer to orientation of taping on Page 3
- (2) CTR RANK  
Please refer to Page 6
- (3) VDE option
- (4) Halogen free option
- (5) Customer code

Example : LTV358TTPA-V-G

**10. NOTES**

- LiteOn is continually improving the quality, reliability, function or design and LiteOn reserves the right to make changes without further notices.
- The products shown in this publication are designed for the general use in electronic applications such as office automation equipment, communications devices, audio/visual equipment, electrical application and instrumentation.
- For equipment/devices where high reliability or safety is required, such as space applications, nuclear power control equipment, medical equipment, etc, please contact our sales representatives.
- When requiring a device for any "specific" application, please contact our sales in advice.
- If there are any questions about the contents of this publication, please contact us at your convenience.
- The contents described herein are subject to change without prior notice.
- Immerge unit's body in solder paste is not recommended.